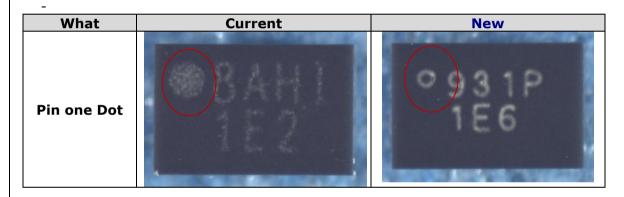
PCN Number:		20190917002.0			PC	N Date:	Sept 18, 2019	
Title:	ing Update for INA191AxIYFDR Device Family							
Customer Contact:		PCN Manager		Dept:	Quality Services			
Change Type:								
Asse	ssembly Site		Assem	Assembly Process			Assembly Materials	
Design			Datash	Datasheet			Mechanical Specification	
Test Site			Packin	Packing/Shipping/Labeling			Test Process	
Wafer Bump Site			Wafer	Wafer Bump Material			Wafer Bump Process	
Wafer Fab Site			Wafer	Wafer Fab Materials			Wafer Fab Process	
			Part nu	Part number change				

PCN Details

Description of Change:

This letter is to inform customers of a device symbolization change for the family of INA191AxIYFDR devices. The Pin one dot will be modified from a filled in dot to an open dot shown in the example below:



No other device changes/symbolization changes are included in this notification.

Reason for Change:

Standardization

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this PCN:

New Pin one dot

Product Affected:

INA191A1IYFDR	INA191A3IYFDR	INA191A4IYFDR	INA191A5IYFDR
INA191A2IYFDR			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN www admin team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.